FOR PATENT APPLICATION (JO NT OR SOLE) (Under 3 CFR § 1.63; with Power of FROMMER LAWRENCE & HAUG LLP ttorney)

FLH File No. 450117-03683

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention ENTITLED:

LINKER MOLECULES FOR SELECTIVE METALLISATION OF NUCLEIC ACIDS AND THEIR USES	
the specification of which	
X is attached hereto.	
was filed on as Application Serial No.	· · · · · · · · · · · · · · · · · · ·
with amendment(s) through	(if applicable, give dates).
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information-known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s) Number: On 126 966.1 Europe Country: Filed (Day/Month/Year): B December 2000 X I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the different bility as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing of the prior application and the national or PCT international filing date of this application: Prior U.S. Application(s) [List additional applications on separate page]: Appln. Ser. Number: Filed (Day/Month/Year): Status (patented, pending, abandoned): I hereby appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to feceive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection file continuation are to be directed to the following correspondence	
WILLIAM S. FROMMER , Esq. c/o FROMMER LAWRENCE & HAUG LLP 745 Fifth Avenue New York, New York 10151 I hereby declare that all statements made herein of my own information and belief are believed to be true; and further that the false statements and the like so made are punishable by fifitle 18 of the United States Code and that such willful false statements are punishable by fifitle 18 of the United States Code and that such willful false statements are punishable by fifitle 18 of the United States Code and that such willful false statements are punishable by fifitle 18 of the United States Code and that such willful false statements are punishable by fifitle 18 of the United States Code and that such willful false statements.	Direct all telephone calls to: (212) 588-0800 to the attention of: WILLIAM S. FROMMER n knowledge are true and that all statements made on these statements were made with the knowledge that ine or imprisonment, or both, under Section 1001 of atements may jeopardize the validity of the application
Signature: William & Sout	Date: 22//V0/01
Full name of sole or first inventor: William FORD Stuttgart, Germany U.S.A.	Date: 22/10/01 Date: 22/10/01
Signature: Full name of 2nd joint inventor (if any): Germany Germany Signature: Full name of 3rd joint inventor (if any): Residence: Citizenship: Akio YASUDA Stuttgart, Germany Citizenship: Signature: Full name of 3rd joint inventor (if any): Akio YASUDA Stuttgart, Germany Japan	Date: 22/10/01
[Similarly list additional inventors on separate page] Post Office Address(es) of inventor(s): [if all inventors have the same post office address]	Advance Technology Center Stuttgart SONY International (Europe) GmbH Heinrich-Hertz-Str. 1 D-70327 Stuttgart GERMANY

Note: In order to qualify for reduced fees available to Small Entities, each inventor and any other individual or entity having rights to the invention must also sign an appropriate separate "Verified Statement (Declaration) Claiming [or Supporting a Claim by Another for] Small Entity Status" form [e.g. for Independent Inventor, Small Business Concern, Nonprofit Organization, individual Non-Inventor].

Note: A post office address must be provided for each inventor.